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PATENTS ONLY

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TO THE HONORABLE COMMISSIONER OF PATENTS AND TRADEMARKS
Washington, D.C. 20231

Please record the attached original documents or copies thereof.

1. Name of conveying party(ies):
M. LEE LOVE, JR., AND KENJI HONDA

06/24/02

2. Name and address of receiving party(ies):
**OLIN MICROELECTRONIC CHEMICALS, INC.
501 MERRITT 7
NORWALK, CONNECTICUT 06856-4500**

3. Nature of conveyance:
XXXXX Assignment _____ Merger
_____ Security Agreement _____ Change of Name
_____ Other: _____
Execution Date: **SEPTEMBER 18, 1997 AND SEPTEMBER 19, 1997**

4. Application number(s) or application date(s):
If this document is being filed together with a new application, the execution date of the application is:
A. Application No. B. Application Date
08/936,035 **SEPTEMBER 23, 1997**

5. Name and address of party to whom correspondence concerning this document should be mailed:

Paul D. Greeley, Esq.
Ohlandt, Greeley, Ruggiero & Perle, L.L.P.
One Landmark Square, 10th Floor
Stamford, Connecticut 06901-2682 U.S.A.

6. Total No. of applications and patents involved: 1.

7. Total Fee (37 C.F.R. 3.41(h)) \$40.00/assignment.
XXXXX Enclosed
_____ Authorized to be charged to deposit account.

The Commissioner is hereby authorized to charge any additional fees under 37 C.F.R. 3.41 that may be required with this communication or credit any overpayment, to Deposit Account No. 01-0467. A duplicate copy of this Form is enclosed.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul D. Greeley
Name of Person Signing
Total number of pages including cover sheet, attachments and document: 4.

Paul D. Greeley
Signature

06/18/02
Date

PATENT
REEL: 013030 FRAME: 0640

07/01/2002 LMUELLER 00000158 08936035 40.00 DP 01 FC:581

ASSIGNMENT

Express Mail No. BM177278195US
Packet No. **101581-100**

WHEREAS, WE: M. Lee Love, Jr. and Kenji Honda, residing at 1535 N. Horne Street, #68, Mesa, Arizona 85203 and 8 Plymouth Drive, Barrington, Rhode Island 02806, respectively, have invented certain new and useful improvements in

"PROCESS FOR REMOVING RESIDUES FROM A SEMICONDUCTOR SUBSTRATE"

Which we:

- (X) have executed an application for Letters Patent of the United States of even date herewith;
- () have filed an application for Letters Patent of the United States on _____ under Serial No. _____ and

WHEREAS, OLIN MICROELECTRONIC CHEMICALS, INC., a corporation of the State of Delaware is desirous of obtaining the entire right, title and interest in, to and under the said improvements and the said application;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over, and by these presents to hereby sell, assign, transfer and set over, unto the said OLIN MICROELECTRONIC CHEMICALS, INC., its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said improvements, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and we hereby authorize and request the Commissioner of Patents of the United States and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvement to the said OLIN MICROELECTRONIC CHEMICALS, INC., its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said OLIN MICROELECTRONIC CHEMICALS, INC., its successors, legal representatives and assigns, any facts known to us respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said OLIN MICROELECTRONIC CHEMICALS, INC., its successors, legal representatives and assigns to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date.....9/18/97....., 1997 M. Lee LovehLS.

Date.....9/19/97....., 1997 X WDRLS.

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